

# 2.5 V or 3.3 V, 200-MHz, 1:18 Clock Distribution Buffer

#### **Features**

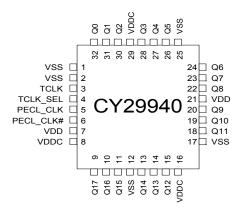
- 200-MHz clock support
- LVPECL or LVCMOS/LVTTL clock input
- LVCMOS/LVTTL compatible inputs
- 18 clock outputs: drive up to 36 clock lines
- 60 ps typical output-to-output skew
- Dual or single supply operation:
  - □ 3.3 V core and 3.3 V outputs
  - $\hfill \ensuremath{\square}$  3.3 V core and 2.5 V outputs
  - □ 2.5 V core and 2.5 V outputs
- Pin compatible with MPC940L, MPC9109
- Available in Commercial and Industrial temperature
- 32-pin LQFP package

### **Description**

The CY29940 is a low-voltage 200-MHz clock distribution buffer with the capability to select either a differential LVPECL or a LVCMOS/LVTTL compatible input clock. The two clock sources can be used to provide for a test clock as well as the primary system clock. All other control inputs are LVCMOS/LVTTL compatible. The eighteen outputs are 2.5 V or 3.3 V LVCMOS/LVTTL compatible and can drive 50  $\Omega$  series or parallel terminated transmission lines. For series terminated transmission lines, each output can drive one or two traces giving the device an effective fanout of 1:36. Low output-to-output skews make the CY29940 an ideal clock distribution buffer for nested clock trees in the most demanding of synchronous systems.

#### **Block Diagram**

#### **Pin Configuration**





# Pin Description<sup>[1]</sup>

Pin	Name	PWR	I/O	Description
5	PECL_CLK		I, PU	PECL Input Clock
6	PECL_CLK#		I, PD	PECL Input Clock
3	TCLK		I, PD	External Reference/Test Clock Input
9, 10, 11, 13, 14, 15, 18, 19, 20, 22, 23, 24, 26, 27, 28, 30, 31, 32	Q(17:0)	VDDC	0	Clock Outputs
4	TCLK_SEL		I, PD	Clock Select Input. When LOW, PECL clock is selected and when HIGH TCLK is selected.
8, 16, 29	VDDC			3.3 V or 2.5 V Power Supply for Output Clock Buffers
7, 21	VDD			3.3 V or 2.5 V Power Supply
1, 2, 12, 17, 25	VSS			Common Ground

Note
1. PD = Internal Pull-Down, PU = Internal Pull-up



#### Maximum Ratings<sup>[2]</sup>

Maximum Input Voltage Relative to $V_{SS}$	V <sub>SS</sub> – 0.3 V
Maximum Input Voltage Relative to $V_{\mbox{\scriptsize DD}}$	V <sub>DD</sub> + 0.3 V
Storage Temperature	. –65 °C to +150 °C
Operating Temperature	–40 °C to +85 °C
Maximum ESD Protection	2 kV
Maximum Power Supply	5.5 V
Maximum Input Current	±20 mA

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field; however, precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range:

$$V_{SS} < (V_{in} \text{ or } V_{out}) < V_{DD}$$

Unused inputs must always be tied to an appropriate logic voltage level (either  $V_{SS}$  or  $V_{DD}$ ).

#### DC Parameters<sup>[2]</sup>

 $V_{DD}$  = 3.3 V ± 5% or 2.5 V ± 5%,  $V_{DDC}$  = 3.3 V ± 5% or 2.5 V ± 5%,  $T_A$  = -40 °C to +85 °C

Parameter	Description	Conditions	Min	Тур	Max	Unit
V <sub>IL</sub>	Input Low Voltage		V <sub>SS</sub>	_	0.8	V
V <sub>IH</sub>	Input High Voltage		2.0	_	$V_{DD}$	V
I <sub>IL</sub>	Input Low Current <sup>[3]</sup>		-	_	-200	μA
I <sub>IH</sub>	Input High Current <sup>[3]</sup>		-	_	200	μA
V <sub>PP</sub>	Peak-to-Peak Input Voltage PECL_CLK		500	_	1000	mV
V <sub>CMR</sub>	Common Mode Range <sup>[4]</sup>	V <sub>DD</sub> = 3.3 V	V <sub>DD</sub> – 1.4	_	V <sub>DD</sub> – 0.6	V
	PECL_CLK	V <sub>DD</sub> = 2.5 V	V <sub>DD</sub> – 1.0	_	V <sub>DD</sub> – 0.6	V
V <sub>OL</sub>	Output Low Voltage <sup>[5, 6, 7]</sup>	I <sub>OL</sub> = 20 mA	_	_	0.5	V
V <sub>OH</sub>	Output High Voltage <sup>[5, 6, 7]</sup>	I <sub>OH</sub> = -20 mA, V <sub>DDC</sub> = 3.3 V	2.4	_	_	V
		$I_{OH} = -20 \text{ mA}, V_{DDC} = 2.5 \text{ V}$	1.8	_	_	V
I <sub>DDQ</sub>	Quiescent Supply Current		-	5	7	mA
I <sub>DD</sub>	Dynamic Supply Current	V <sub>DD</sub> = 3.3 V, Outputs @ 150 MHz, CL = 15 pF	_	285	_	mA
		V <sub>DD</sub> = 3.3 V, Outputs @ 200 MHz, CL = 15 pF	_	335	-	
		V <sub>DD</sub> = 2.5 V, Outputs @ 150 MHz, CL = 15 pF	-	200	_	
		V <sub>DD</sub> = 2.5 V, Outputs @ 200 MHz, CL = 15 pF	-	240	_	
Z <sub>out</sub>	Output Impedance	V <sub>DD</sub> = 3.3 V	8	12	16	Ω
		V <sub>DD</sub> = 2.5 V	10	15	20	
C <sub>in</sub>	Input Capacitance		_	4	_	pF

#### Notes

- 2. **Multiple Supplies:** The Voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is not required.
- 3. Inputs have pull-up/pull-down resistors that effect input current.
- The VCMR is the difference from the most positive side of the differential input signal. Normal operation is obtained when the "High" input is within the VCMR range and the input lies within the VPP specification. Driving series or parallel terminated 50 Ω (or 50 Ω to V<sub>DD</sub>/2) transmission lines
- 5. Outputs driving 50  $\Omega$  transmission lines.
- 6. See Figure 1 on page 5 and Figure 2 on page 5.
- 7. 50% input duty cycle.



#### **AC Parameters**<sup>[8]</sup>

 $V_{DD}$  = 3.3 V ± 5% or 2.5 V ± 5%,  $V_{DDC}$  = 3.3 V ± 5% or 2.5 V ± 5%,  $T_A$  = -40 °C to +85 °C

Parameter	Description	Description Conditions		Min	Тур	Max	Unit
F <sub>max</sub>	Input Frequency		_	_	_	200	MHz
t <sub>PD</sub>	PECL_CLK to Q Delay <sup>[9, 10, 11]</sup> ≤ 150 MHz	V <sub>DD</sub> = 3.3 V, 85 °C	$t_{PHL}$	2.0	_	3.2	ns
			$t_{PLH}$	2.1	_	3.4	
		V <sub>DD</sub> = 3.3 V, 70 °C	$t_{PHL}$	1.9	_	3.1	
			$t_{PLH}$	2.0	_	3.2	
		V <sub>DD</sub> = 2.5 V, 85 °C	t <sub>PHL</sub>	2.5	_	5.2	
			$t_{PLH}$	2.6	_	5	
		V <sub>DD</sub> = 2.5 V, 70 °C	t <sub>PHL</sub>	2.5	_	5	
			$t_{PLH}$	2.6	_	5	
t <sub>PD</sub>	LVCMOS to Q Delay <sup>[9, 10, 11]</sup> ≤ 150 MHz	V <sub>DD</sub> = 3.3 V, 85 °C	$t_{PHL}$	1.9	_	3	ns
			$t_{PLH}$	2.0	_	3.2	
		V <sub>DD</sub> = 3.3 V, 70 °C	t <sub>PHL</sub>	1.8	_	2.9	
			$t_{PLH}$	1.8	_	3.1	
		V <sub>DD</sub> = 2.5 V, 85 °C	$t_{PHL}$	2.5	_	4	
			$t_{PLH}$	2.5	_	4	
		V <sub>DD</sub> = 2.5 V, 70 °C	t <sub>PHL</sub>	2.3	_	3.8	
			$t_{PLH}$	2.3	_	3.8	
t <sub>J</sub>	Total Jitter	V <sub>DD</sub> = 3.3 V @ 150 MHz		_	_	10	ps
FoutDC	Output Duty Cycle <sup>[9, 10, 12]</sup>	FCLK < 134 MHz		_	_	55	%
		FCLK > 134 MHz		_	_	60	
T <sub>skew</sub>	Output-to-Output Skew <sup>[9, 10]</sup>	V <sub>DD</sub> = 3.3 V		_	60	150	ps
		V <sub>DD</sub> = 2.5 V		_	_	200	
T <sub>skew</sub> (pp)	Part-to-Part Skew <sup>[13]</sup>	PECL, V <sub>DDC</sub> = 3.3 V		_	_	1.4	ns
		PECL, V <sub>DDC</sub> = 2.5 V		_	_	2.2	
T <sub>skew</sub> (pp)	Part-to-Part Skew <sup>[13]</sup>	TCLK, V <sub>DDC</sub> = 3.3 V		_	_	1.2	ns
		TCLK, V <sub>DDC</sub> = 2.5 V		_	_	1.7	
T <sub>skew</sub> (pp)	Part to Part Skew <sup>[14]</sup>	PECL_CLK		_	_	850	ps
-		TCLK		_	_	750	
t <sub>R</sub> /t <sub>F</sub>	Output Clocks Rise/Fall Time <sup>[9, 10]</sup>	0.7 V to 2.0 V, V <sub>DDC</sub> = 3.3	3 V	0.3	_	1.1	ns
		0.5 V to 1.8 V, V <sub>DDC</sub> = 2.5	5 V	0.3	_	1.2	1

<sup>8.</sup> Parameters are guaranteed by design and characterization. Not 100% tested in production. All parameters specified with loaded outputs.
9. Outputs driving 50 Ω transmission lines.
10. See Figure 1 on page 5 and Figure 2 on page 5.
11. Parameters tested @ 150 MHz.

<sup>12.50%</sup> input duty cycle.

<sup>13.</sup> Across temperature and voltage ranges, includes output skew.

<sup>14.</sup> For a specific temperature and voltage, includes output skew.



Figure 1. LVCMOS\_CLK CY29940 Test Reference for  $V_{CC}$  = 3.3 V and  $V_{CC}$  = 2.5 V

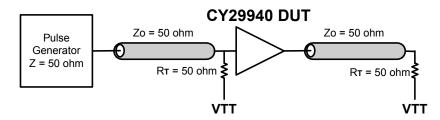


Figure 2. PECL\_CLK CY29940 Test Reference for  $\rm V_{CC}$  = 3.3 V and  $\rm V_{CC}$  = 2.5 V

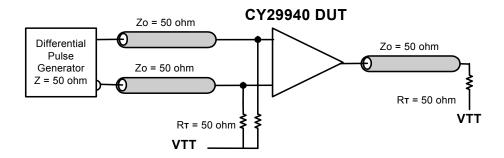


Figure 3. Propagation Delay (TPD) Test Reference

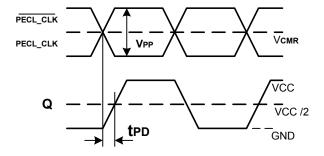
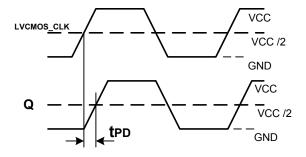


Figure 4. LVCMOS Propagation Delay (TPD) Test Reference



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Figure 5. Output Duty Cycle (FoutDC)

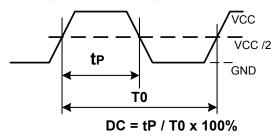
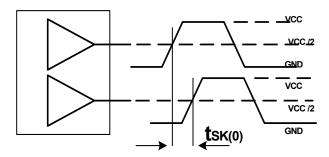


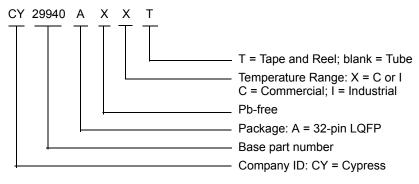
Figure 6. Output-to-Output Skew tsk(0)



# **Ordering Information**

Part Number	Package Type	Production Flow
Pb-free		
CY29940AXI	32-pin LQFP	Industrial, –40 °C to +85 °C
CY29940AXIT	32-pin LQFP – Tape and Reel	Industrial, –40 °C to +85 °C
CY29940AXC	32-pin LQFP	Commercial, 0 °C to 70 °C
CY29940AXCT	32-pin LQFP – Tape and Reel	Commercial, 0 °C to 70 °C

#### **Ordering Code Definitions**

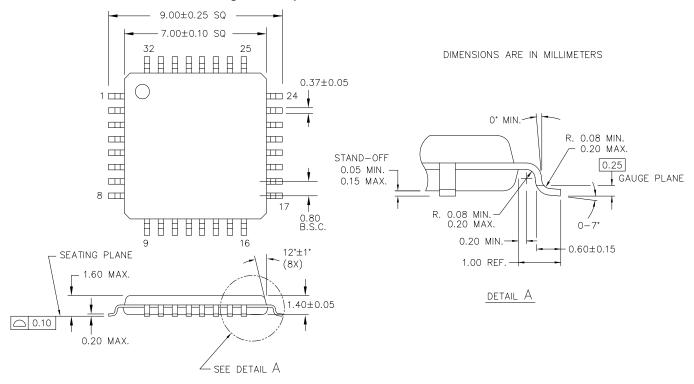


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# **Package Drawing and Dimensions**

Figure 7. 32-pin TQFP 7 × 7 × 1.4 mm A32.14



51-85088 \*C



# Acronyms

Acronym	Description	
ESD	electrostatic discharge	
I/O	input/output	
LQFP	low-profile quad flat package	
LVCMOS	CMOS low voltage complementary metal oxide semiconductor	
LVPECL	low-voltage positive emitter-coupled logic	
LVTTL	low-voltage transistor-transistor logic	
TQFP	thin quad flat pack	

# **Document Conventions**

#### **Units of Measure**

Symbol	Unit of Measure		
°C	degree Celsius		
kV	kilo Volts		
MHz	Mega Hertz		
μΑ	micro Amperes		
mA	milli Amperes		
mm	milli meter		
mV	milli Volts		
ns	nano seconds		
Ω	ohms		
%	percent		
pF	pico Farad		
ps	pico seconds		
V	Volts		
W	Watts		



# **Document History Page**

Document Number: 38-07283						
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change		
**	111094	02/01/02	BRK	New data sheet		
*A	116776	08/15/02	HWT	Incorporate results of final characterization using corporate methods, added output impedance on page 3 and added output duty cycle on page 4. Add commercial temperature range in the ordering information on page 6.		
*B	122875	12/21/02	RBI	Add power up requirements to maximum rating information		
*C	448379	See ECN	RGL	Add typical value for output-to-output skew Add Lead-free devices		
*D	2899304	03/25/10	BASH/KVM	Removed inactive parts from Ordering Information. Updated package diagram.		
*E	3254185	05/11/2011	CXQ	Added Ordering Code Definitions. Added Acronyms and Units of Measure. Updated in new template.		



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